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Part Number: [87832-1010](#)
Status: **Active**
Overview: [Milli-Grid™](#)
Description: 2.00mm Pitch Milli-Grid™ Header, Surface Mount, Vertical, Shrouded, Lead-Free, 10 Circuits, 0.38µm Gold (Au) Plating, with Locking Window, without Cap, PCB Locator, Tube

Documents:
[3D Model](#) [Product Specification PS-87831-027 \(PDF\)](#)
[Drawing \(PDF\)](#) [RoHS Certificate of Compliance \(PDF\)](#)

Agency Certification

CSA	LR19980
UL	E29179

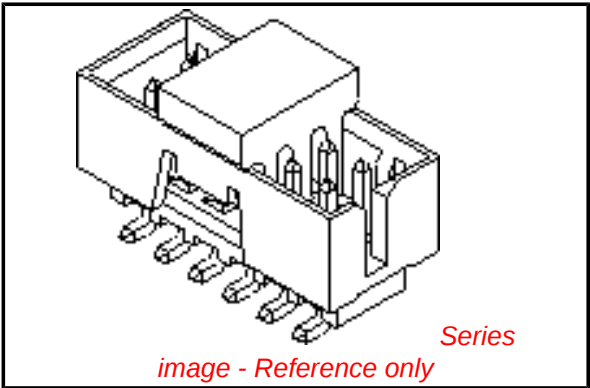
General

Product Family	PCB Headers
Series	87832
Application	Signal, Wire-to-Board
Comments	Contact Molex for application in automotive industry
Overview	Milli-Grid™
Product Name	Milli-Grid™

Physical

Breakaway	No
Circuits (Loaded)	10
Circuits (maximum)	10
Color - Resin	Black
Durability (mating cycles max)	100
First Mate / Last Break	No
Flammability	94V-0
Glow-Wire Compliant	No
Guide to Mating Part	No
Keying to Mating Part	Yes
Lock to Mating Part	Yes
Material - Metal	Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	Nylon
Number of Rows	2
Orientation	Vertical
PCB Locator	No
PCB Retention	None
Packaging Type	Tube
Pitch - Mating Interface	2.00mm
Pitch - Termination Interface	2.00mm
Plating min - Mating	0.381µm
Plating min - Termination	1.905µm
Polarized to PCB	No
Shrouded	Fully
Stackable	No
Surface Mount Compatible (SMC)	Yes
Temperature Range - Operating	-55°C to +105°C
Termination Interface: Style	Through Hole and Surface Mount

Electrical



EU RoHS
ELV and RoHS
Compliant
REACH SVHC
Contains SVHC: No
Low-Halogen Status
Not Low-Halogen



Need more information on product environmental compliance?

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series
[87832Series](#)

Mates With
50394 Wire-to-Board Terminals, 51110 Wire-to-Board Crimp Housing, 87568 Wire-to-Board IDT Housings, 79107 Board-to-Board Top Entry Through Hole Receptacle, 79108 Board-to-Board FFC/FPC Top Entry Through Hole Receptacle, L

Current - Maximum per Contact	2A
Voltage - Maximum	125V

Solder Process Data

Duration at Max. Process Temperature (seconds)	10
Lead-free Process Capability	Reflow Capable (SMT only)
Max. Cycles at Max. Process Temperature	1
Process Temperature max. C	260

Material Info

Reference - Drawing Numbers

Product Specification	PS-87831-027
Sales Drawing	SD-87832-010

This document was generated on 03/29/2012

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